

Support & training

TEXAS INSTRUMENTS

TPS922052, TPS922053, TPS922054, TPS922055 SLVSGG9A – JUNE 2023 – REVISED SEPTEMBER 2023

TPS92205x 65-V 2-A / 4-A Buck LED Driver with Inductive Fast Dimming

1 Features

- 4.5-V to 65-V wide input range
- LED common anode connection
- Integrated 150-mΩ MOSFET with typical 3-A / 6-A current limit
- Optional switching frequency: 100 kHz to 2.2 MHz
- Spread spectrum for TPS922053 and TPS922055
- Advanced dimming options:
	- Analog dimming (256:1)
	- Fast PWM dimming (150-ns pulse width)
	- Hybrid and flexible dimming (2,000:1 at 20-kHz PWM, 10,000:1 at 4-kHz PWM, 1,000,000:1 at 120-Hz PWM)
- CC / CV charging mode
- Full protection features:
	- LED open and short protection
	- Switching FET open and short protection
	- External component failure protection
	- Cycle-by-cycle current limit
	- Thermal shutdown
	- Fault output (open drain)
	- Configurable thermal foldback curve
- VSON, WSON and SOT23 package options

2 Applications

- Constant illumination:
	- Indoor, outdoor, professional lighting
	- Medical, surgical lighting
	- Projector, laser TV, printer, IP camera
- Instant illumination:
	- Machine vision, camera flash
	- Fire alarm, strobe
- CC and CV source:
- LCD backlighting
- Battery charging
- TEC control

Simplified Schematic

3 Description

The TPS92205x family is a 2-A / 4-A nonsynchronous Buck LED driver with 4.5-V to 65-V wide input range. By integrating the low-side NMOS switch, the device is capable of driving LEDs as well as charging batteries with high power density and high efficiency. The family also supports common anode connection and single layer PCB design. The switching frequency is configurable from 100 kHz to 2.2 MHz with optional spread spectrum feature for better EMI performance.

The TPS92205x family supports four dimming options, including analog, PWM, hybrid and flexible dimming. Each dimming method can be configured through the PWM and ADIM input pins by means of simple high and low signals. The family adopts an adaptive off-time current mode control along with smart and accurate sampling to enable inductive fast dimming (IFD) and achieve high dimming accuracy.

The TPS92205x family also provides multiple systematic protections, including LED open and short, sense resistor open and short, configurable thermal foldback and thermal shutdown. A Fault output sends out acknowledge signals as soon as any fault condition is detected.

Device Information

LED Brightness Linearity

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, $\overline{\textbf{44}}$ intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

5 Device Comparison Table

6 Pin Configuration and Functions

Table 6-1. Pin Functions

(1) $I = Input, O = Output, P = Supply, G = Ground$

7 Specifications

7.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted) (1)

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. Theseare stress ratings only, which do not imply functional operation of the device at these or anyother conditions beyond those indicated under *Recommended OperatingConditions*. Exposure to absolute-maximum-rated conditions for extended periods mayaffect device reliability.

7.2 ESD Ratings

(1) JEDEC document JEP155 states that 500-V HBM allows safemanufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safemanufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

7.4 Thermal Information

(1) For more information about traditional and new thermalmetrics, see the *Semiconductor and IC Package Thermal Metrics*application report, SPRA953.

7.5 Electrical Characteristics

The electrical ratings specified in this section apply to all specifications in this document, unless otherwise noted. These specifications are interpreted as conditions that do not degrade the device parametric or functional specifications for the life of the product containingit. T_J = –40°C to +125°C, V_{IN} = 4.5 V to 60 V, (unlessotherwise noted).

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7.6 Typical Characteristics

 V_{IN} = 24 V, I_{OUT} = 3 A, LED count = 2, L = 10 µH, F_{SW} = 400 kHz, unless otherwise specified

7.6 Typical Characteristics (continued)

8 Detailed Description

8.1 Overview

The TPS92205x family is a 2-A / 4-A non-synchronous Buck LED driver with 4.5-V to 65-V wide input range. By integrating the low-side NMOS switch with constant current and constant voltage controls, the device is capable of not only driving LEDs but also charging batteries with high power density and high efficiency. The device also supports common anode connection and single layer PCB design, hence saving cost of connector, harness and PCB. The switching frequency is configurable through FSET pin, ranging from 100 kHz to 2.2 MHz, with optional spread spectrum feature to decrease the EMC emission and reduce the input filter size.

The device supports four dimming options, including analog dimming, PWM dimming, hybrid dimming and flexible dimming. Each dimming method can be configured through the PWM and ADIM input pins by means of simple high/low sequencing signals at startup. In PWM dimming mode, once the dimming mode is configured, LED is turned on and off corresponding to on and off of the PWM input signal at PWM input pin. The PWM dimming mode supports ultra-narrow pulse width down to 150 ns. In analog dimming mode, LED current is regulated corresponding to the pulse width duty cycle of the PWM input signal at ADIM input pin. In hybrid dimming mode, the LED current is controlled by a pre-determined combination of analog dimming and PWM dimming through the PWM input signal at PWM input pin. In flexible dimming mode, the LED current is controlled by analog dimming through the PWM input signal at ADIM input pins and PWM dimming through the PWM input signal at PWM input pins, respectively. The device adopts an adaptive off-time current mode control along with smart and accurate sampling to enable Inductive Fast Dimming (IFD) and achieve high dimming accuracy. The compensation bandwidth can be adjusted through an external capacitor based on system requirement.

For safety and protection, the devices support full systematic protections including LED open and short, sense resistor open and short, configurable thermal foldback and thermal shutdown protection. The fault output pin sends out acknowledge signals as soon as any fault condition is detected.

8.2 Functional Block Diagram

8.3 Feature Description

8.3.1 Adaptive Off-Time Current Mode Control

The TPS92205x device adopts an adaptive off-time current mode control to support fast transient response over a wide range of operation. The switching frequency is configurable through FSET pin, ranging from 100 kHz to 2.2 MHz.

For average output current regulation, the sensed voltage across the sensing resistor between the CSP and CSN pins is compared with the internal voltage reference, V_{RFF} , through the error amplifier. The output of the error amplifier, V_{COMP} , passes through an external compensation network and is then compared with the peak current feedback at the PWM comparator. During each switching cycle, when the internal NMOS FET is turned on, the peak currernt is sensed through the internal FET. When the sensed value of peak current reaches V_{COMP} at the input of PWM comparator, the NMOS FET is turned off and the adaptive off-time counter starts counting. Once the adaptive off-time counter stops counting, the counter is reset until when the NMOS FET stays off. The counting off time is determined by the external resistor connected to the FSET pin and the input/output feedforward. Thus, the device is able to maintain a nearly constant switching frequnecy at steady state and regulate the output average current at a desired value.

Figure 8-1. Adaptive off-time current mode control method

8.3.1.1 Switching Frequency Settings

The switching frequency of TPS92205x device is adjustable from 100 kHz to 2.2 MHz by means of changing R_{FSFT} connected between FSET pin and AGND. The default switching frequency is 100 kHz when the FSET pin is connected to nothing.

The resistor value and the corresponding switching frequency are listed in the below table:

$\overline{}$ Switching Frequency	. Resistor Value ($k\Omega$)
100 kHz	232
200 kHz	138
300 kHz	83
400 kHz	59
600 kHz	38
800 kHz	28
1 MHz	23
1.2 MHz	18
1.5 MHz	13
1.8 MHz	11
2.2 MHz	9

Table 8-1. Switching Frequency vs. R_{ESET} Resistor Value

(1)

For example, if R_{FSET} is set to 59 k Ω , the corresponding switching frequency is set to 400 kHz.

In most cases, the lower switching frequency, the higher system efficiency and the better thermal behavior.

8.3.1.2 Spread Spectrum

The TPS922053 and TPS922055 devices enable the spread spectrum feature $(\pm 7\%$ from central frequency, 2-kHz modulation frequency) which reduces EMI noise at the switching frequency and its high-order harmonics.

On the other hand, the TPS922052 and TPS922054 devices disable the spread spectrum feature toward better brightness performance in low brightness scenario.

8.3.2 Setting LED Current

The LED current is set by the external sensing resistor between CSP and CSN pins. The internal voltage reference, V_{REF} , is fixed at 200 mV for full-scale LED current, I_{LEDFS} , and the sensing resistor can be calculated using Equation 1.

$$
R_{SENSE} = \frac{V_{REF}}{I_{LED_FS}}
$$

where

• V_{RFF} = 200 mV

8.3.3 Undervoltage Lockout

The TPS92205x family implements an internal undervoltage-lockout (UVLO) circuitry connecting to the VCC pin. The UVLO is triggered and then the device is disabled when the VCC pin voltage falls below the internal UVLO threshold voltage, V_{VIN UVLO} typically 3.0 V, with a typical 0.2-V hysteresis. The VCC pin is the output of an internal regulator of which the input is supplied by the VIN pin. Therefore, if VIN pin voltage falls close to above the V_{VIN} $_{\text{UVLO}}$ (around 500 mV above), the UVLO will be triggered.

8.3.4 Internal Soft Start

The TPS92205x family implements the internal soft-start function. Once V_{IN} rises above $V_{VIN-MIN}$, the internal LDO starts to charge V_{CC} capacitor. It takes approximately 800 μs for V_{CC} to rise above V_{VIN UVLO} if a 1-μF capacitor is connected to V_{CC} pin. If EN/PWM pin is pulled high before V_{CC} rises above V_{VIN UVLO}, the POR is enabled right after V_{CC} above V_{VIN UVLO} and waits for 100 μs to start dimming mode. EN/PWM pin has to stay high for more than 5 μs after V_{CC} rises above V_{VIN UVLO}. In this case, if using 1-μF V_{CC} capacitor, it is recommended to wait for 1 ms to start dimming mode after V_{IN} rises above $V_{VIN-MIN}$.

If EN/PWM pin has the first PWM pulse appearing after V_{CC} rises above V_{VIN UVLO}, the device waits for 200 µs to enable POR and another 100 μs to start dimming mode. Hence, without triggering V_{IN} UVLO, the device can be renabled after disabled and waits for 300 μs to start dimming mode. Note that the initial enable PWM pulse lasting more than 5 μs is required at EN/PWM input pin to enable the device. After dimming mode is started, the device enters four different dimming modes based on the configuration of ADIM/HD pin and EN/PWM pin.

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Figure 8-2. Startup Sequence

8.3.5 Dimming Mode

The TPS92205x family has four optional dimming modes:

- PWM dimming
- Analog dimming
- Hybrid dimming
- Flexible dimming

The dimming mode is started either 1 ms after V_{IN} exits UVLO or 300 µs after renable by EN/PWM pin. The configuration to one of the four dimming modes are shown as below

Table 8-2. Dimming Mode Configuration

8.3.5.1 PWM Dimming

The TPS92205x family supports PWM input signals with ultra-narrow pulse width down to 150 ns for direct PWM dimming. The PWM dimming mode is enabled when the ADIM/HD input pin is always high and the EN/PWM input pin is configured by a PWM input signal.

In PWM dimming mode, when the PWM input signal at the PWM pin turns from low to high, the internal NMOS FET starts switching and the inductor current rises to the determined value. The LED current is then regulated at the determined value as long as the PWM input signal stays high. When the PWM input signal turns from high to low, the internal FET is turned off causing the inductor current falling to zero. The internal FET maintains off and the LED current stays zero as long as the PWM input signal stays low.

8.3.5.2 Analog Dimming

The TPS92205x family supports analog dimming which regulates the LED current through the PWM input signal at the ADIM/HD pin. The analog dimming mode is enabled when the EN/PWM pin is always high and the ADIM/HD pin is configured by a PWM input signal.

The internal voltage reference, V_{REF} , starts to rise after the first PWM pulse appears at the ADIM/HD pin. A 1-µs minimum on-time of the first PWM pulse is required for the internal digital circuits to enter the analog dimming mode. V_{REF} continues to increase until the end of second PWM cycle and then changes to the desired value in proportion to the duty cycle of the PWM pulse. The minimum on-time of the PWM pulse after the first is 100 ns for the digital circuits to detect the duty cycle.

 V_{REF} is 200 mV when the PWM input signal at the ADIM/HD pin has a 100% duty cycle, for instance, and V_{REF} is 20 mV when the PWM input signal has a 10% duty cycle. The initial change takes approximately 5 ms if V_{REF} is 200 mV. The analog dimming enables 8-bit resolution which corresponds to 0.4% duty cycle step change at the ADIM/HD pin. Also, the circuit is able to respond to the duty cycle change of the PWM input signal with tens of micro-seconds delay.

8.3.5.3 Hybrid Dimming

The TPS92205x family supports a unique hybid dimming function to maximize the dimming performance, especially when both high dimming frequency and high dimming ratio are needed. The hybrid dimming mode is enabled when the ADIM/HD pin is always low and the EN/PWM pin is configured by a PWM input signal.

In the hybrid dimming mode, the LED current is regulated by the analog dimming at high brightness level (12.5% to 100%) and by the PWM dimming at low brightness level (0% to 12.5%), respectively. At high brightness level, the internal voltage reference, V_{REF} , changes in proportion to the duty cycle of the PWM input signal at the EN/PWM pin with 8-bit resolution. At low brightness level, V_{REF} stays unchanged and an internal PWM generator is enabled. Thus, the LED is turned on and off corresponding to the on and off of the internal PWM signal of which the frequency and the duty cycle are configured by the PWM input signal at the EN/PWM pin. In addition, the internal PWM signal has a 0.4% hystersis response when the PWM input duty cycle changes between increasing and decreasing. The detailed hybrid dimming behavior is illustrated in the below figure.

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Figure 8-3. Hybrid Dimming

8.3.5.4 Flexible Dimming

The TPS92205x family also supports flexible dimming to maximize the dimming ratio and the flexibility of dimming control, in which the LED current value and the on/off behavior can be controlled independently. The flexible dimming mode is enabled when both the ADIM/HD pin and the EN/PWM pin are configured by PWM input signals at the same time. Therefore, in fleixble dimming mode, the LED is turned on and off corresponding to the on and off of the PWM input signal at the EN/PWM pin while the reference voltage changes in proportion to the duty cycle of the PWM input signal at the ADIM/HD pin. All the initial conditions and resolutions of PWM dimming and analog dimming apply to the flexible dimming.

Figure 8-4. Flexible Dimming

8.3.6 CC/CV Charging Mode

The TPS92205x family enables constant current (CC) / constant voltage (CV) charging operation by configuring UVP pin. When V_{UVP} is above the CC threshold V_{CC TH} determined by users, the device performs as a controllable constant current source and generates a relatively low output current controlled by a low-duty-cycle PWM signal at ADIM/HD pin for pre-charge. When V_{UVP} is below $V_{CC~TH}$ but above 1.4 V, the device generates a relatively high output current controlled by a high-duty-cycle PWM signal at ADIM/HD pin for CC operation. CV charging mode is enabled and the output current continuously decreases after V_{UVP} falls below 1.4 V. The device then returns to CC operation mode once V_{UVP} rises above 1.4 V.

Figure 8-5. CC/CV Mode Transition

8.3.7 Fault Protection

The TPS92205x family is able to provide fault protections and send fault report signals in many fault conditions, including LED open, LED ± short, LED short to PGND, sense resistor open and short, internal switching FET open and short, and thermal shutdown.

Table 8-3. Protections

8.3.8 Thermal Foldback

The TPS92205x family integrates thermal shutdown protection to prevent the device from overheating. In order to provide design margin of system thermal performance, the device enables a programmable thermal foldback function which automatically reduces the full-scale max output current, I_{MAX} , at high junction temperature. When the device along with the LEDs are mounted on the same thermal substrate, the thermal performance is effectively improved due to the reduction of dissipation need for both device and LED.

As the device junction temperature rises above the thermal foldback threshold temperature, T_{TH} , the full-scale max current starts to reduce following the current-temperature curve shown in the below figure. The current starts to reduce from the 100% level at typically rate of 2% of I_{MAX} per °C until it drops to 50% of the full scale. Once the junction temperature rises 25°C above the T_{TH} , the current continues to decrease at a lower rate until the temperature reaches above the overtemperature shutdown threshold temperature, T_{TSD} .

The T_{TH} can be adjusted by changing the resistor R_{TEMP} connected between the TEMP and AGND pin. The T_{TH} and the corresponding R_{TEMP} value are listed in below table.

Table 0-4. TH vs. INTEMP resistor value	
T _{TH} (°C)	Resistor Value ($k\Omega$)
80	200
90	100
100	60
110	40
120	28
130	20
140	15
150	10

Table 8-4. T_{TH} vs. R_{TEMP} resistor value

9 Application and Implementation

9.1 Application Information

The TPS92205x family is typically used as a Buck converter to drive one or more LEDs from an input from 4.5-V to 63-V range.

9.2 Typical Application

9.2.1 TPS922054 24-V Input, 4-A Output, 4-piece WLED Driver With Analog Dimming

9.2.1.1 Design Requirements

For this design example, use the parameters in the following table.

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Inductor Selection

For this design, the input voltage is a 24-V, rail with 10% variation. The output is 4 white LEDs in series and the inductor current ripple by requirement is less than 30% of maximum inductor current. To choose a proper peak-to-peak inductor current ripple, the low-side FET current limit should not be violated when the converter works in full-load condition. This requires half of the peak-to-peak inductor current ripple to be lower than that limit. Another consideration is to ensure reasonable inductor core loss and copper loss caused by the peak-to-peak current ripple. Once this peak-to-peak inductor current ripple is chosen, use Equation 2 to calculate the recommended value of the output inductor L.

$$
L = \frac{V_{OUT} \times (V_{IN(max)} - V_{OUT})}{V_{IN(max)} \times K_{IND} \times I_{L(max)} \times f_{SW}}
$$
(2)

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- $I_{L(max)}$ is the maximum inductor current.
- f_{SW} is the switching frequency.
- $V_{IN(max)}$ is the maximum input voltage.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor current ripple using Equation 3.

$$
I_{L(rimple)} = \frac{V_{OUT} \times (V_{IN(max)} - V_{OUT})}{V_{IN(max)} \times L \times f_{SW}}
$$
\n(3)

The ratings of inductor RMS current and saturation current must be greater than those seen in the system requirement. This is to ensure no inductor overheat or saturation occurring. During power up, transient conditions or fault conditions, the inductor current may exceed its normal operating current and reach the current limit. Therefore, it is preferred to select a saturation current rating equal to or greater than the converter current limit. The peak-inductor-current and RMS current equations are shown in Equation 4 and Equation 5.

$$
I_{L(peak)} = I_{L(max)} + \frac{I_L(ripple)}{2} \tag{4}
$$

$$
I_{L(rms)} = \sqrt{I_{L(max)}^2 + \frac{I_L(ripple)^2}{12}}
$$
\n
$$
\tag{5}
$$

In this design, $V_{IN(max)}$ = 24 V, V_{OUT} = 12 V, I_{LED} = 4 A, f_{SW} = 400 kHz, choose K_{IND} = 0.3, the calculated inductance is 12.5 µH. A 15-µH inductor is chosen. With this inductor, the ripple, peak, and rms currents of the inductor are 1 A, 4.5 A, and 4.01 A, respectively.

9.2.1.2.2 Input Capacitor Selection

An input capacitor is required to reduce the surge current drawn from the input supply and the switching noise coming from the device. Electrolytic capacitors are recommended for energy storage. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, it is recommended to place a 10-μF ceramic capacitor along with a 0.1-µF capacitor from VIN to PGND/AGND to provide high-frequency filtering. The input capacitor voltage rating must be greater than the maximum input voltage. Use Equation 6 to calculate the input ripple voltage, where ESR_{CIN} is the ESR of input capacitor, and K_{DR} is the derating coefficient of ceramic capacitance at the applied DC voltage.

$$
V_{IN(ripple)} = I_{L(max)} \times \left(\frac{V_{OUT}}{K_{DR} \times C_{IN} \times f_{SW} \times V_{IN(max)}} + ESR_{CIN}\right)
$$
(6)

In this design, a 68-µF, 100V electrolytic capacitor, a 22-µF, 100V X7R ceramic capacitor and a 0.1-µF, 100V X7R ceramic capacitor are chosen, yielding around 240-mV input ripple voltage.

9.2.1.2.3 Output Capacitor Selection

The output capacitor reduces the high-frequency current ripple through the LED string. Excessive current ripple increases the RMS current in the LED string, therefore increasing the LED temperature.

1. Calculate the total dynamic resistance of the LED string (R_{LED}) using the LED manufacturer's datasheet.

2. Calculate the required impedance of the output capacitor (Z_{OUT}) given the acceptable peak-to-peak ripple current through the LED string, $I_{LED(ripple)}$. $I_{L(ripple)}$ is the peak-to-peak inductor ripple current as calculated with the selected inductor.

3. Calculate the minimum effective output capacitance required.

4. Increase the output capacitance appropriately due to the derating effect of applied DC voltage.

See Equation 7, Equation 8, and Equation 9.

$$
R_{LED} = \frac{\Delta V_F}{\Delta I_F} \times \# \ of \ LEDs \tag{7}
$$

$$
Z_{COUT} = \frac{R_{LED} \times I_{LED}(ripple)}{I_L(ripple) - I_{LED}(ripple)}
$$
(8)

$$
C_{COUT} = \frac{1}{2\pi \times f_{SW} \times Z_{COUT}}\tag{9}
$$

Once the output capacitor is chosen, Equation 10 can be used to estimate the peak-to-peak ripple current through the LED string.

$$
I_{LED(ripple)} = \frac{Z_{COUNT} \times I_{L(ripple)}}{Z_{COUNT} + R_{LED}} \tag{10}
$$

CREE WLED is used here. The dynamic resistance of the LED is 0.67 ohm at 3-A forward current. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. In this design, a 2.2-µF, 100-V X7R ceramic capacitor and a 0.1-µF, 100-V X7R ceramic capacitor are chosen. The calculated ripple current of the LED is about 210 mA.

9.2.1.2.4 Sense Resistor Selection

The maximum LED current is 4 A at 100% PWM duty and the corresponding V_{REF} is 200 mV. By using Equation 1, the sense resistance is calculated as 50 m Ω .

Note that the power consumption of the sense resistor is 800 mW, requiring enough margin of the resistor's power rating in selection.

9.2.1.2.5 Other External Components Selection

In this design, a 0.1-µF, 50-V X7R ceramic capacitor is chosen for high-frequency filtering of sense feedback.

For loop stability, it is recommended to select a 1-nF, 10-V X7R ceramic capacitor for C_{COMP}. A 1-MΩ resistor is chosen for R_{DAMP} to suppress the overshoot current at rising edge of PWM on.

9.2.1.3 Application Curves

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COLLED Cathode **CO** FAULT **EAULT** ^{cs} +_induc **B** i-inducto **B**LLED TWEE TREE TO THE TABLE TO T **Discovery of the Contract of Street** $6 \qquad \frac{691}{3624} \qquad \frac{569}{3624} \qquad \frac{1066}{364} \qquad \frac{1066666}{364 \cdot 1251656} \qquad \frac{10666}{3640364} \qquad \frac{10}{10}$ 40 units 400 un Black: UVP, Light Blue: SW, Red: FAULT, Orange: Inductor Black: UVP, Light Blue: SW, Red: FAULT, Orange: Inductor Current, Deep Blue: LED Current Current, Green: LED- Voltage **Figure 9-8. LED Open-Load Protection Figure 9-9. LED– Short-to-PGND Protection** File Edit USR **External FAULT** CO CSP-CSN o Linducto **Execute B** LLED \overline{m} + ind $6\qquad \frac{\text{Add}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Add}}\ \underset{\text{Mup}}{\text{Add}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Add}}\qquad \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{Mup}}{\text{Mup}}\ \underset{\text{M$ Black: LED- Voltage, Light Blue: SW, Red: FAULT, Orange: Black: UVP, Light Blue: SW, Red: FAULT, Orange: Inductor Inductor Current, Deep Blue: LED Current Current, Green: CSP-CSN **Figure 9-10. LED+ and LED– Short-Circuit Figure 9-11. Switching FET Short-Circuit Protection Protection CSP-CS** FAULT $\frac{1}{2}$ **Co.** FAULT \overline{a} i LED \bullet i_ind **Example 19 (1999)**
 Call Controlling Street Transfer (CD / 500 mV | Antan, Analyte

Street Transfer Street Transfer (CD / 500 mV | Hann Rosinger | 17

Street Transfer Transfer (CD / 500 mV | Street Transfer Transfer Tra The Street Street Street Street Street Street **FEED TO AND THE CONSUMER** Light Blue: SW, Red: FAULT, Orange: Inductor Current, Deep Black: COMP, Light Blue: SW, Red: FAULT, Orange: Inductor Blue: LED Current, Green: CSP-CSN Current, Green: CSP-CSN **Figure 9-13. Sense-Resistor Short-Circuit Figure 9-12. Sense-Resistor Open Protection Protection**

9.2.2 TPS922054 48-V Input, 2-A Output, 12-piece WLED Driver with PWM Dimming

9.2.2.1 Design Requirements

For this design example, use the parameters in the following table.

Table 9-2. Design Parameters

PARAMETER	VALUE
Input voltage range	48 V ±10%
LED forward voltage	3.0V
Output voltage	$36 V (3.0 \times 12)$
Maximum LED current	2 A
Inductor current ripple	40% of maximum inductor current
LED current ripple	200 mA or less
Input voltage ripple	600 mV or less
Dimming type	PWM dimming with TPS922054: 20-kHz, 1% to 100% PWM input at the PWM pin

9.2.2.2 Detailed Design Procedure

9.2.2.2.1 Inductor Selection

For this design, the input voltage is a 48-V, rail with 10% variation. The output is 12 white LEDs in series and the inductor current ripple by requirement is less than 40% of maximum inductor current. To choose a proper peak-to-peak inductor current ripple, the low-side FET current limit should not be violated when the converter works in no-load condition. This requires half of the peak-to-peak inductor current ripple to be lower than that limit. Another consideration is to ensure reasonable inductor core loss and copper loss caused by the peak-to-peak current ripple. Once this peak-to-peak inductor current ripple is chosen, use Equation 11 to calculate the recommended value of the output inductor L.

$$
L = \frac{V_{OUT} \times (V_{IN(max)} - V_{OUT})}{V_{IN(max)} \times K_{IND} \times I_{L(max)} \times f_{SW}}
$$
\n(11)

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- $I_{L(max)}$ is the maximum inductor current.
- f_{SW} is the switching frequency.
- $V_{IN(max)}$ is the maximum input voltage.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor current ripple using Equation 12.

$$
I_{L(rimple)} = \frac{V_{OUT} \times (V_{IN(max)} - V_{OUT})}{V_{IN(max)} \times L \times f_{SW}}
$$
\n(12)

The ratings of inductor RMS current and saturation current must be greater than those seen in the system requirement. This is to ensure no inductor overheat or saturation occurring. During power up, transient conditions or fault conditions, the inductor current may exceed its normal operating current and reach the current limit. Therefore, it is preferred to select a saturation current rating equal to or greater than the converter current limit. The peak-inductor-current and RMS current equations are shown in Equation 13 and Equation 14.

$$
I_{L(peak)} = I_{L(max)} + \frac{I_L(ripple)}{2} \tag{13}
$$

$$
I_{L(rms)} = \sqrt{I_{L(max)}^2 + \frac{I_L(ripple)^2}{12}}
$$
\n
$$
(14)
$$

In this design, $V_{IN(max)}$ = 48 V, V_{OUT} = 36 V, I_{LED} = 2 A, f_{SW} = 1.2 MHz, choose K_{IND} = 0.4, the calculated inductance is 9.4 µH. A 10-µH inductor is chosen. With this inductor, the ripple, peak, and rms currents of the inductor are 0.75 A, 2.4 A, and 2.01 A, respectively.

9.2.2.2.2 Input Capacitor Selection

An input capacitor is required to reduce the surge current drawn from the input supply and the switching noise coming from the device. Electrolytic capacitors are recommended for energy storage. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, it is recommended to place a 10-μF capacitor along with a 0.1-µF capacitor from VIN to PGND/AGND to provide high-frequency filtering. The input capacitor voltage rating must be greater than the maximum input voltage. Use Equation 15 to calculate the input ripple voltage, where ESR_{CIN} is the ESR of input capacitor, and K_{DR} is the derating coefficient of ceramic capacitance at the applied DC voltage.

$$
V_{IN(ripple)} = I_{L(max)} \times \left(\frac{V_{OUT}}{K_{DR} \times C_{IN} \times f_{SW} \times V_{IN(max)}} + ESR_{CIN}\right)
$$
\n(15)

In this design, a 10-µF, 100V electrolytic capacitor, a 2.2-µF, 100V X7R ceramic capacitor and a 0.1-µF, 100V X7R ceramic capacitor are chosen, yielding around 570-mV input ripple voltage.

9.2.2.2.3 Output Capacitor Selection

The output capacitor reduces the high-frequency current ripple through the LED string. Excessive current ripple increases the RMS current in the LED string, therefore increasing the LED temperature.

1. Calculate the total dynamic resistance of the LED string (R_{LED}) using the LED manufacturer's datasheet.

2. Calculate the required impedance of the output capacitor (Z_{OUT}) given the acceptable peak-to-peak ripple current through the LED string, $I_{LED(ripple)}$. $I_{L(ripple)}$ is the peak-to-peak inductor ripple current as calculated with the selected inductor.

3. Calculate the minimum effective output capacitance required.

4. Increase the output capacitance appropriately due to the derating effect of applied DC voltage.

See Equation 16, Equation 17, and Equation 18.

$$
R_{LED} = \frac{\Delta V_F}{\Delta I_F} \times \# \ of \ LEDs \tag{16}
$$

$$
Z_{COUT} = \frac{R_{LED} \times I_{LED}(ripple)}{I_L(ripple) - I_{LED}(ripple)}
$$
(17)

$$
C_{COUT} = \frac{1}{2\pi \times f_{SW} \times Z_{COUT}}\tag{18}
$$

Once the output capacitor is chosen, Equation 19 can be used to estimate the peak-to-peak ripple current through the LED string.

$$
I_{LED(ripple)} = \frac{Z_{COUNT} \times I_{L(ripple)}}{Z_{COUNT} + R_{LED}} \tag{19}
$$

Cree WLED is used here. The dynamic resistance of the LED is 0.67 ohm at 1-A forward current. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. In this design, a 1-µF, 100-V X7R ceramic capacitor and a 0.1-µF, 100-V X7R ceramic capacitor are chosen. The calculated ripple current of the LED is about 120 mA.

9.2.2.2.4 Sense Resistor Selection

The maximum LED current is 2 A at 100% PWM duty and the corresponding V_{REF} is 200 mV. By using Equation 1, the sense resistance is calculated as 100 m Ω .

Note that the power consumption of the sense resistor is 400 mW, requiring enough margin of the resistor's power rating in selection.

9.2.2.2.5 Other External Components Selection

In this design, a 0.1-µF, 50-V X7R ceramic capacitor is chosen for high-frequency filtering of sense feedback.

For loop stability, it is recommended to select a 1-nF, 10-V X7R ceramic capacitor for C_{COMP}. A 1-MΩ resistor is chosen for R_{DAMP} to suppress the overshoot current at rising edge of PWM on.

9.2.2.3 Application Curves

TPS922052, TPS922053, TPS922054, TPS922055

SLVSGG9A – JUNE 2023 – REVISED SEPTEMBER 2023 **www.ti.com**

9.3 Power Supply Recommendations

The device is designed to operate from an input voltage supply ranging between 4.5 V and 65 V. This input supply must be well regulated. The device requires an input capacitor to reduce the surge current drawn from the input supply and the switching noise from the device. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10-μF capacitor is enough.

9.4 Layout

The TPS92205x family requires a proper layout for optimal performance. The following section gives some guidelines to ensure a proper layout.

9.4.1 Layout Guidelines

An example of a proper layout for the TPS92205x family is shown in .Section 9.4.2

- Creating a large PGND plane for good electrical and thermal performance is important.
- The IN and PGND traces should be as wide as possible to reduce trace impedance. Wide traces have the additional advantage of providing excellent heat dissipation.
- Thermal vias can be used to connect the top-side PGND plane to additional printed-circuit board (PCB) layers for heat dissipation and grounding.
- The input capacitors must be located as close as possible to the IN pin and the PGND/AGND pin.
- The VCC capacitor should be placed as close as possible to VCC pin to ensure stable LDO output voltage.
- The SW trace must be kept as short as possible to reduce parasitic inductance and thereby reduce transient voltage spikes. Short SW trace also reduces radiated noise and EMI.
- Do not allow switching current to flow under the device.
- The routing of CSN and CSP traces are recommended to be in parallel and kept as short as possible and placed away from the high-voltage switching trace and the ground shield.
- The compensation capacitor must be placed as close as possible to COMP pin so as to prevent oscillation and system instability.

9.4.2 Layout Example

Figure 9-27. 14-Pin SOT-23-TH Top View Layout Example

10 Device and Documentation Support

10.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

10.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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10.3 Trademarks

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10.4 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

10.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the mostcurrent data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.

PACKAGING INFORMATION

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

PACKAGE OPTION ADDENDUM

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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GENERIC PACKAGE VIEW

DMT 14 VSON - 0.9 mm max height

3 x 4.5, 0.65 mm pitch PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

PACKAGE OUTLINE

DMT0014D VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

DMT0014D VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

DMT0014D VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

PACKAGE OUTLINE

SOT-23-THIN - 1.1 mm max height DYY0014A

PLASTIC SMALL OUTLINE

- per ASME Y14.5M.
This drawing is subject to change without notice.
-
- 0.15 per side.
-
-

EXAMPLE BOARD LAYOUT

DYY0014A SOT-23-THIN - 1.1 mm max height

PLASTIC SMALL OUTLINE

NOTES: (continued)

-
-

EXAMPLE STENCIL DESIGN

DYY0014A SOT-23-THIN - 1.1 mm max height

PLASTIC SMALL OUTLINE

NOTES: (continued)

- design recommendations.
Board assembly site may have different recommendations for stencil design.
-

GENERIC PACKAGE VIEW

DRR 12 WSON - 0.8 mm max height

3 x 3, 0.5 mm pitch PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

PACKAGE OUTLINE

DRR0012C WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.

3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

DRR0012C WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

DRR0012C WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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